

TECHNICAL CHARACTERISTICS

1. General Characteristics

Dimension: 29.65L x 17.20W x 2.50H mm
 Weight: Approx. 0.95 g
 Contact principle: Friction technology
 Operating position: Shaft up / Down / Horizontal
 Mounting System: SMT Type (post optional)
 Durability: 10,000 cycles min.

2. Mechanical Characteristics

Insulation material:
 Thermoplastic, Natural, UL 94V-0
 RoHS Directive 2011/65/EU Compliant

3. Electrical Characteristics

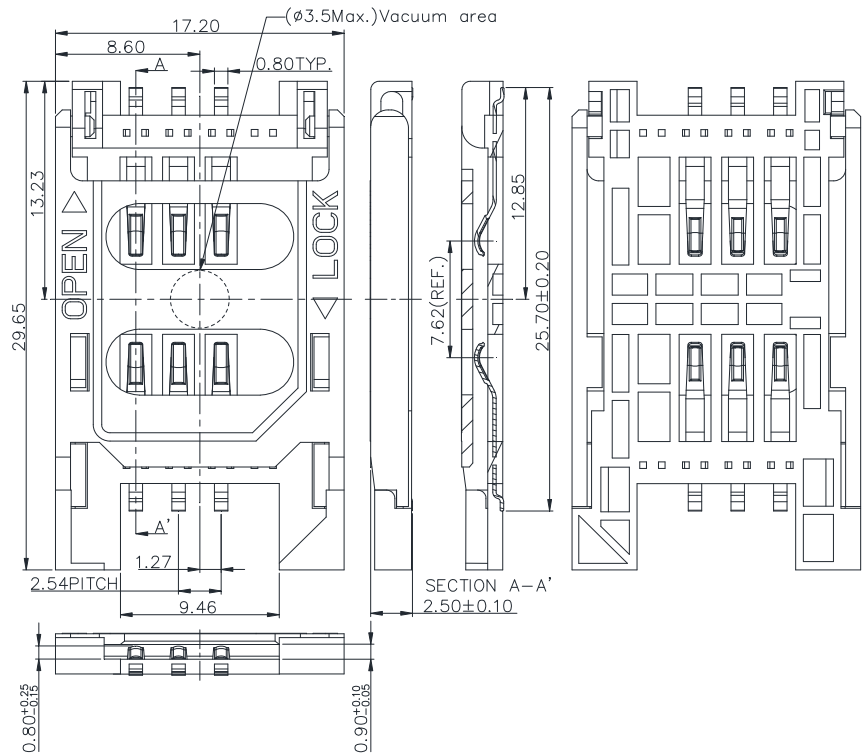
Number of contacts: 6, 8 pins (optional)
 Contact resistance: 50 mΩ typical, 100 mΩ max.
 Insulation resistance: >1000 MΩ / 500 VDC

4. Solderability

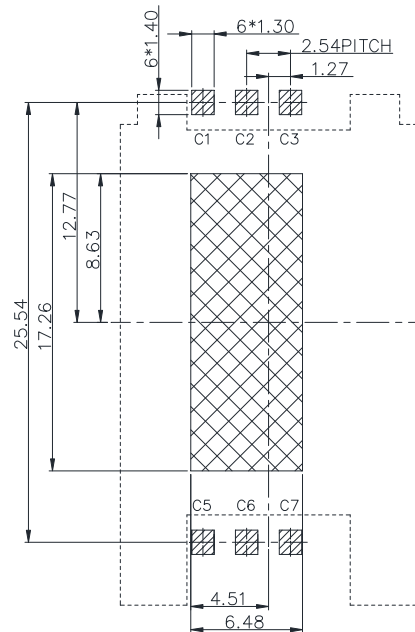
Wave: Not applicable
 IR reflow: 260°C, 10 sec. Max.
 Manual soldering: 360°C, 3 sec. Max.

5. Environmental Characteristics

Operating temperature: - 40°C ~ + 85°C
 Operating humidity: 10 % ~ 95 % RH
 Storage temperature: - 40°C ~ + 85°C
 Storage humidity: 10 % ~ 95 % RH



Unit: mm; Tolerances: ±0.15 mm
Mechanical outline dimension



Unit: mm; Tolerances: ±0.05 mm
Reference dimension for PCB layout

H&V SIM Card Acceptor

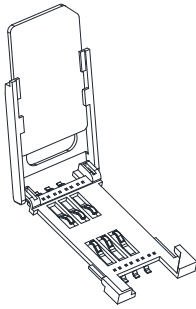
Model No.: ICA-521 6Pin

Revision: 2.0

Date: OCT. 23, 2015

Note:

1. Coplanarity of solder pins 0.10mm max.
2. Recommended thickness of solder paste > 0.15mm.



TECHNICAL CHARACTERISTICS

1. General Characteristics

Dimension: 29.65L x 17.20W x 2.50H mm
 Weight: Approx. 0.95 g
 Contact principle: Friction technology
 Operating position: Shaft up / Down / Horizontal
 Mounting System: SMT Type (post optional)
 Durability: 10,000 cycles min.

2. Mechanical Characteristics

Insulation material:
 Thermoplastic, Natural, UL 94V-0
 RoHS Directive 2011/65/EU Compliant

3. Electrical Characteristics

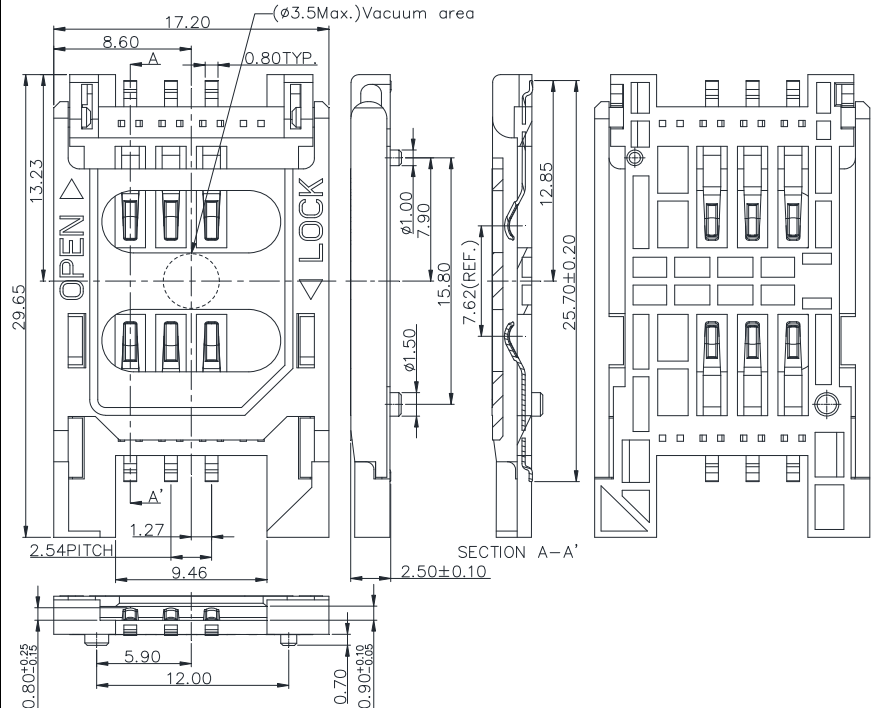
Number of contacts: 6, 8 pins (optional)
 Contact resistance: 50 mΩ typical, 100 mΩ max.
 Insulation resistance: >1000 MΩ / 500 VDC

4. Solderability

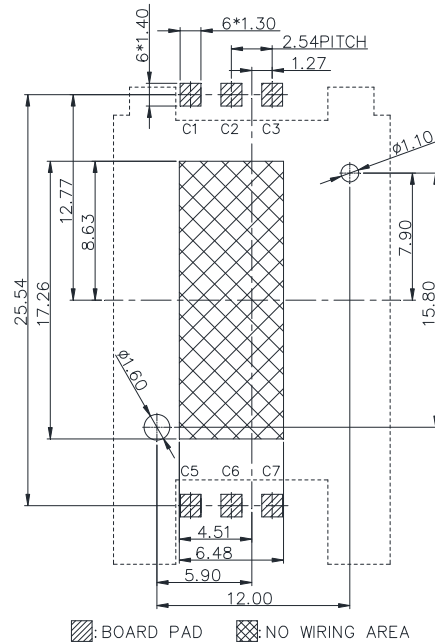
Wave: Not applicable
 IR reflow: 260°C, 10 sec. Max.
 Manual soldering: 360°C, 3 sec. Max.

5. Environmental Characteristics

Operating temperature: - 40°C ~ + 85°C
 Operating humidity: 10 % ~ 95 % RH
 Storage temperature: - 40°C ~ + 85°C
 Storage humidity: 10 % ~ 95 % RH



Unit: mm; Tolerances: ±0.15 mm
 Mechanical outline dimension



Unit: mm; Tolerances: ±0.05 mm
 Reference dimension for PCB layout

Note:

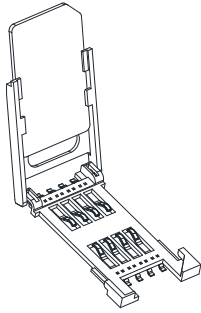
- Coplanarity of solder pins 0.10mm max.
- Recommended thickness of solder paste > 0.15mm.

H&V SIM Card Acceptor

Model No.: ICA-521 6Pin+Post

Revision: 2.0

Date: OCT. 23, 2015



TECHNICAL CHARACTERISTICS

1. General Characteristics

Dimension: 29.65L x 17.20W x 2.50H mm
 Weight: Approx. 0.95 g
 Contact principle: Friction technology
 Operating position: Shaft up / Down / Horizontal
 Mounting System: SMT Type (post optional)
 Durability: 10,000 cycles min.

2. Mechanical Characteristics

Insulation material:
 Thermoplastic, Natural, UL 94V-0
 RoHS Directive 2011/65/EU Compliant

3. Electrical Characteristics

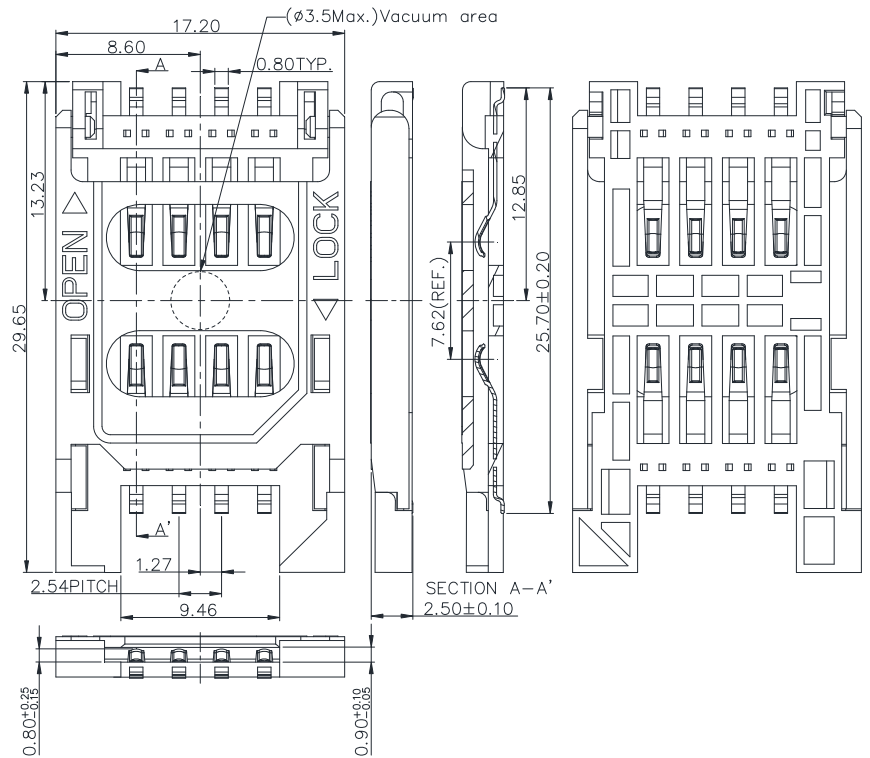
Number of contacts: 6, 8 pins (optional)
 Contact resistance: 50 mΩ typical, 100 mΩ max.
 Insulation resistance: >1000 MΩ / 500 VDC

4. Solderability

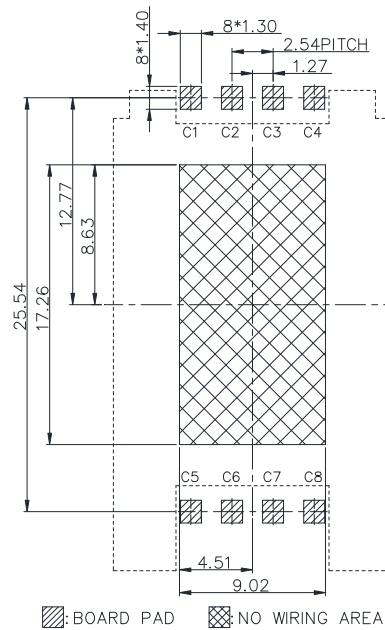
Wave: Not applicable
 IR reflow: 260°C, 10 sec. Max.
 Manual soldering: 360°C, 3 sec. Max.

5. Environmental Characteristics

Operating temperature: - 40°C ~ + 85°C
 Operating humidity: 10 % ~ 95 % RH
 Storage temperature: - 40°C ~ + 85°C
 Storage humidity: 10 % ~ 95 % RH



Unit: mm; Tolerances: ±0.15 mm
Mechanical outline dimension



Unit: mm; Tolerances: ±0.05 mm
Reference dimension for PCB layout

Note:

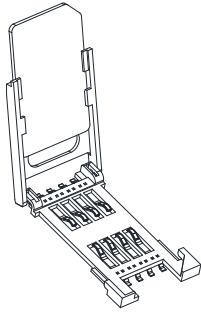
- Coplanarity of solder pins 0.10mm max.
- Recommended thickness of solder paste > 0.15mm.

H&V SIM Card Acceptor

Model No.: ICA-521 8Pin

Revision: 2.0

Date: OCT. 23, 2015



TECHNICAL CHARACTERISTICS

1. General Characteristics

Dimension: 29.65L x 17.20W x 2.50H mm
 Weight: Approx. 0.95 g
 Contact principle: Friction technology
 Operating position: Shaft up / Down / Horizontal
 Mounting System: SMT Type (post optional)
 Durability: 10,000 cycles min.

2. Mechanical Characteristics

Insulation material:
 Thermoplastic, Natural, UL 94V-0
 RoHS Directive 2011/65/EU Compliant

3. Electrical Characteristics

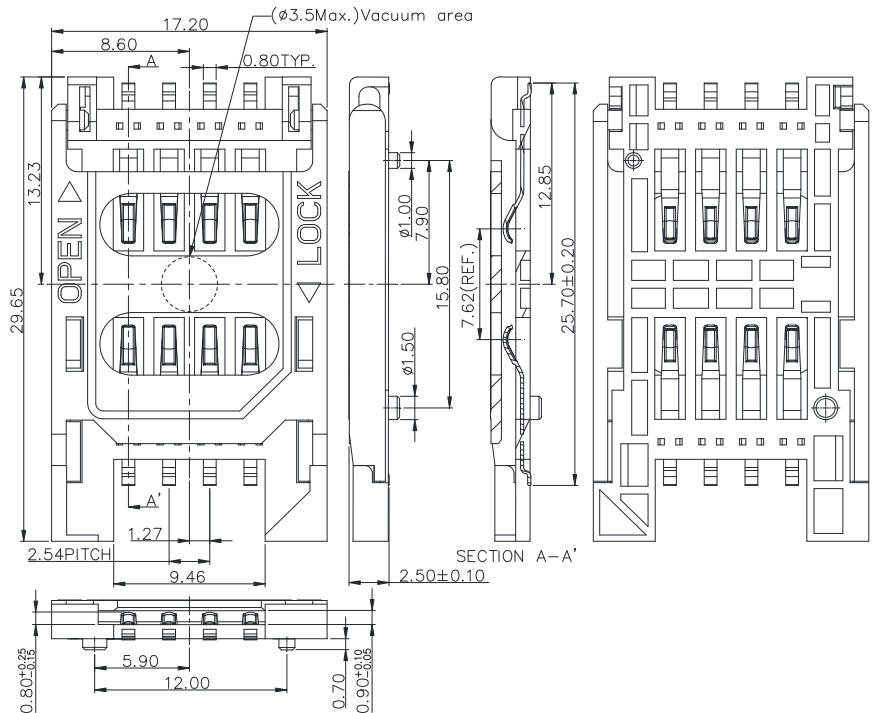
Number of contacts: 6, 8 pins (optional)
 Contact resistance: 50 mΩ typical, 100 mΩ max.
 Insulation resistance: >1000 MΩ / 500 VDC

4. Solderability

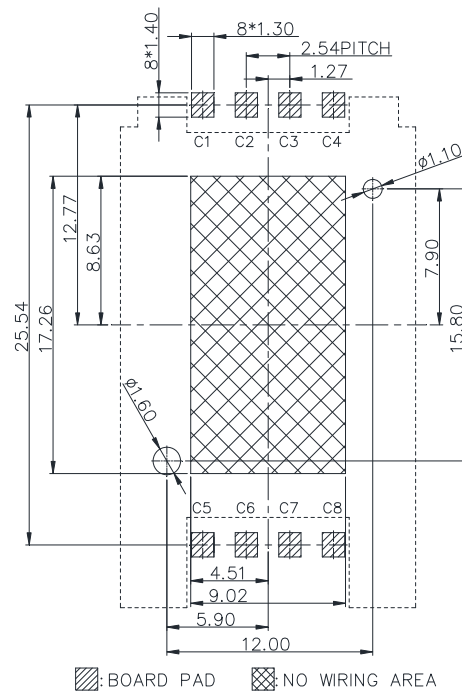
Wave: Not applicable
 IR reflow: 260°C, 10 sec. Max.
 Manual soldering: 360°C, 3 sec. Max.

5. Environmental Characteristics

Operating temperature: - 40°C ~ + 85°C
 Operating humidity: 10 % ~ 95 % RH
 Storage temperature: - 40°C ~ + 85°C
 Storage humidity: 10 % ~ 95 % RH



Unit: mm; Tolerances: ±0.15 mm
Mechanical outline dimension



▨: BOARD PAD ▩: NO WIRING AREA

Unit: mm; Tolerances: ±0.05 mm
Reference dimension for PCB layout

H&V SIM Card Acceptor

Model No.: ICA-521 8Pin+Post

Revision: 2.0 Date: OCT. 23, 2015

Note:

1. Coplanarity of solder pins 0.10mm max.
2. Recommended thickness of solder paste > 0.15mm.